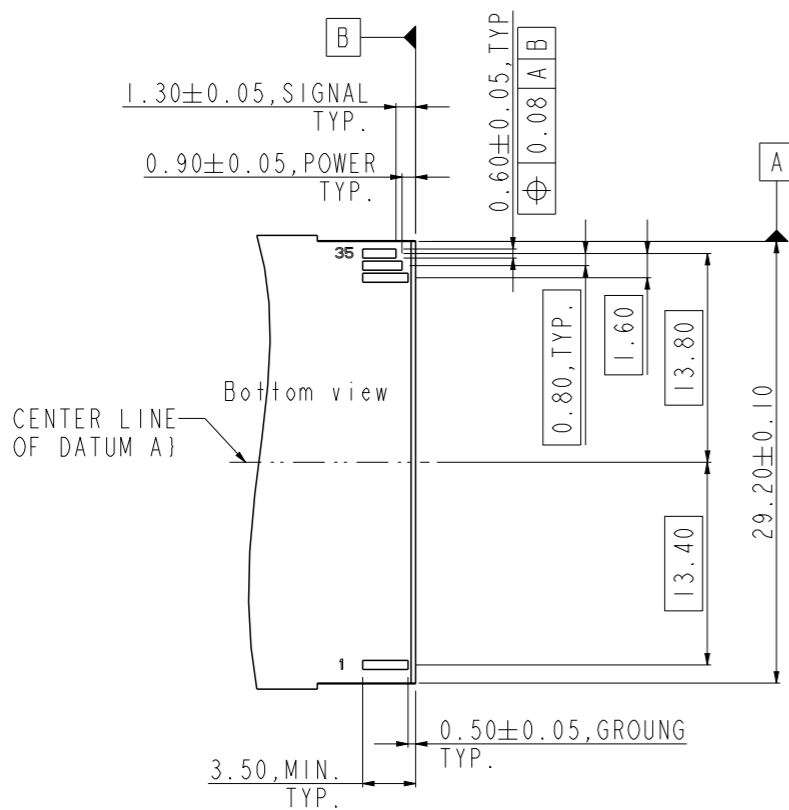
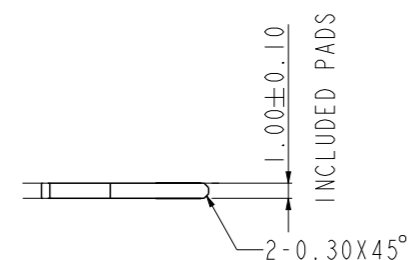
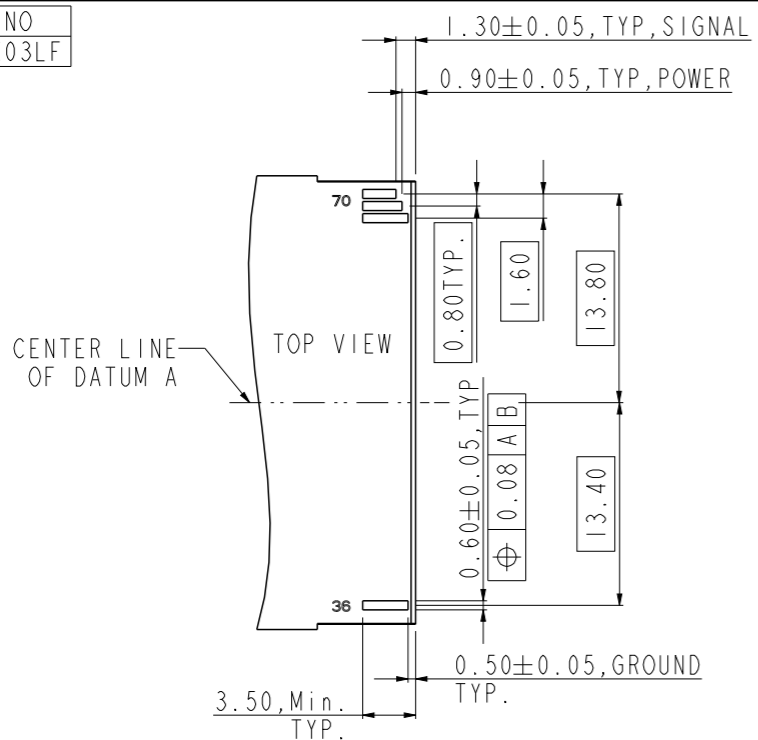


- NOTE:
- Material:
    - HOUSING: HIGH TEMPERATURE LCP, BLACK UL 94 V-0 FLAME RETARDANT.
    - TERMINAL: NICKEL COPPER ALLOY. PLATING SPEC AS BELOW:
      - FOR CONTACT AREA:
        - 103LF FOR 0.76 MICROMETERS MIN. THICKNESS GOLD.
        - 203LF FOR 0.38 MICROMETERS MIN. THICKNESS GOLD
        - 903LF FOR 0.76 MICROMETERS MIN. THICKNESS GXT
      - FOR SOLDER AREA:
        - MATTE PURE TIN 3 MICROMETERS MIN.
        - 2.54 MICROMETERS MIN. THICKNESS NICKEL
      - FOR UNDERPLATING:
        - 2.54 MICROMETERS MIN. THICKNESS NICKEL
  - PACKING SPEC. GS-14-1030.
  - PRODUCT SPEC. GS-12-557.
  - PART NUMBER SCHEME: (EX. 10084423-X03LF), PLEASE FIND THE PAGE 2 FOR OPTIONS.
  - LEAD FREE NOTES:
    - 5a. THE HOUSING WILL WITHSTAND EXPOSURE TO 260° C PEAK TEMPERATURE FOR 10 SECONDS IN A COVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
    - 5b. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
  - THIS CONNECTOR IS DESIGNED TO WORK WITH RAIL SYSTEM THAT ALLOW THE MODULE TO "FLOAT" IN THE VERTICAL PLANE AND FIND EQUILIBRIUM BETWEEN THE UPPER AND LOWER CONTACT ROWS. THIS CONNECTOR WILL NOT PERFORM PROPERLY IF USED IN SYSTEMS THAT MECHANICALLY BIAS THE MODULE IN THE VERTICAL PLANE SUCH AS RAIL SYSTEMS WITH EMI SPRINGS.

Copyright FCI.

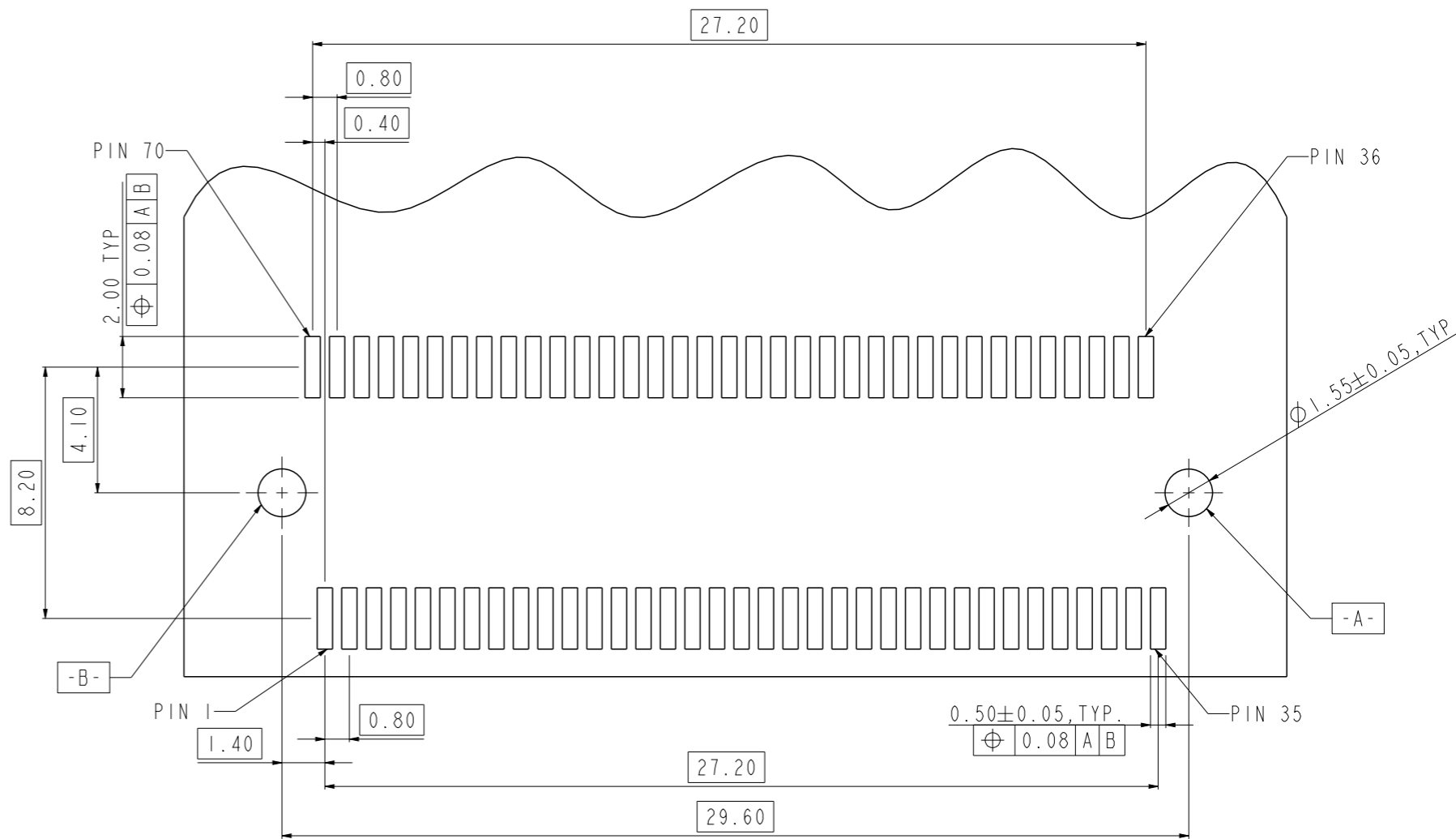
spec ref	*	dr	Junon Huang	2009/04/21	projection	MM	size	A3	scale	5.000
tolerance std	ISO 406 ISO 1101	eng	De-Feng, Qin	2012/03/22			ecn no	ELX-DG-010777-1	rel level	Released
TOLERANCES UNLESS OTHERWISE SPECIFIED		chr	Terry Qiu	2012/03/26						
surface	ISO 1302	appr	Pei-Ming Zheng	2012/03/26	product family					
	linear	0.X	±0.50		title ASSEMBLY. STANDARD TYPE. 70 POS RIGHT ANGLE TYPE. EDGE CARD CONNECTOR	dwg no 10084423-103	rev D			
		0.XX	±0.25							
		0.XXX	±0.10							
	angular	0°	±2°	www.fci.com	cat. no.	*	Product - Customer Drw	sheet 1 of 2		

PRODUCT NO  
10084423-X03LF



RECOMMENDED LAYOUT  
MATING PCB SIDE

PART NUMBER	TERMINALS (Contact plating options)	TERMINALS (Underplating and Solder tail plating)	REMARK
10084423-103LF	0.76um, Min. Gold	Underplating: 2.54um Min. Nickel overall. Solder tail: 3um Min. Matte Tin.	
10084423-203LF	0.38um Min. Gold	Underplating: 2.54um Min. Nickel overall. Solder tail: 3um Min. Matte Tin.	
10084423-903LF	0.76um, Min. GXT	Underplating: 2.54um Min. Nickel overall. Solder tail: 3um Min. Matte Tin.	



SCALE 5.000  
RECOMMENDED PCB LAYOUT  
CONNECTOR MOUNTING SIDE

spec ref	*	dr	Junon Huang	2009/04/21	projection	MM	size	A3	scale	2.000	
tolerance std	ISO 406 ISO 1101	eng	De-Feng, Qin	2012/03/22			ecn no	ELX-DG-010777-1			
TOLERANCES UNLESS OTHERWISE SPECIFIED		chr	Terry Qiu	2012/03/26			rel level	Released			
surface	linear	appr	Pei-Ming Zheng	2012/03/26	product family	dwg no		10084423-103		rev	D
ISO 1302	angular	www.fci.com		cat. no.	*	Product - Customer Drw		sheet 2 of 2			



Copyright FCI.